

APPLICATION DATA SHEET

APPLICATION INFORMATION

Application Type:: REGULAR
Subject Matter:: UTILITY
CD-ROM or CD-R?:: NONE
Title:: HIGH FREQUENCY FLIP CHIP MODULE AND
ASSEMBLING METHOD THEREOF
Attorney Docket Number:: 214306US2RD
Total Drawing Sheets:: 21
Small Entity?:: NO

INVENTOR INFORMATION

Inventor Authority Type:: INVENTOR
Primary Citizenship Country:: Japan
Status:: FULL CAPACITY
Given Name:: Yuji
Family Name:: ISEKI
City of Residence:: Kanagawa
Country of Residence:: Japan
Street:: c/o Intellectual Property Division,
Toshiba Corporation, 1-1, Shibaura 1-chome
Minato-ku
City:: Tokyo
State or Province:: Japan
Country::

Inventor Authority Type:: INVENTOR
Primary Citizenship Country:: Japan
Status:: FULL CAPACITY
Given Name:: Naoko
Family Name:: ONO
City of Residence:: Tokyo
Country of Residence:: Japan
Street:: c/o Intellectual Property Division,
Toshiba Corporation, 1-1, Shibaura 1-chome
Minato-ku
City:: Tokyo
State or Province:: Japan
Country::

Inventor Authority Type:: INVENTOR
Primary Citizenship Country:: Japan
Status:: FULL CAPACITY
Given Name:: Keiichi
Family Name:: YAMAGUCHI
City of Residence:: Kanagawa
Country of Residence:: Japan
Street:: c/o Intellectual Property Division,
Toshiba Corporation, 1-1, Shibaura 1-chome
Minato-ku
City:: Tokyo
State or Province:: Japan
Country::

CORRESPONDENCE INFORMATION

Correspondence Customer Number:: 22850

REPRESENTATIVE INFORMATION

Representative Customer Number:: 22850

FOREIGN PRIORITY INFORMATION

Country:: Japan
Application Number:: 2000-294053
Filing Date:: 09/27/00

ASSIGNMENT INFORMATION

Assignee Name:: KABUSHIKI KAISHA TOSHIBA
Street:: 1-1, Shibaura 1-chome
City:: Minato-ku
State or Province:: Tokyo
Country:: Japan